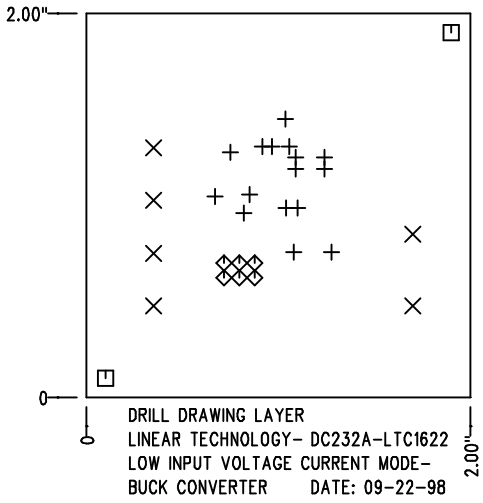
REVISIONS			
REV	DESCRIPTION	APPR	DATE
A	PROTOTYPE RELEASE		

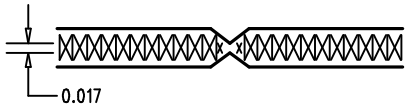


SHOWN FROM COMPONENT SIDE

SIZE	QTY	SYM	PLTD
0.02	16	+	PLTD
0.094	6	X	PLTD
0.07	2	□	NPLTD
0.035	6	◇	PLTD

NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
   THICKNESS .062 +/-.006 TOTAL OF 2 LAYERS.
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
   ELECTRODEPOSITED TIN-LEAD COMPOSITION
   BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC).
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT.
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK.
5. UNUSED SMD COMPONENTS SHOULD BE FREE OF SOLDER.
6. FILL UP ALL VIAS WITH SOLDER.
7. SCORING:



8. PLEASE LOOK AT THE README FILE FOR THE OTHER REQUIREMENTS.

APPROVALS		
	INIT	DATE
DRAWN		
CHECK		
DESIGN	KIM T.	09-22-98
ENGR	S.W.CHEE	09-22-98
SCALE = NONE		

LINEAR TECHNOLOGY
1630 McCarthy Blvd.
Milpitas, CA 95035
PH: (408)432-1900

TITLE: Fabrication Drawing
LOW INPUT VOLTAGE CURRENT MODE
BUCK CONVERTER

SIZE	DEMO	REV.
A	DC232A-LTC1622MS8	A

DES- 0000 SHT 1 of 1